



## MICROCIRCUIT DATA SHEET

**MNLP2951-X REV 1B1**

Original Creation Date: 08/01/95  
Last Update Date: 05/19/98  
Last Major Revision Date: 11/11/96

### ADJUSTABLE MICROPOWER VOLTAGE REGULATORS

#### General Description

The LP2951 is a micropower voltage regulator with very low dropout voltage (typ. 40 mV at light loads and 380 mV at 100 mA). It is ideally suited for use in battery-powered systems. Furthermore, the quiescent current of the LP2951 increases only slightly in dropout, prolonging battery life.

An attractive feature is an error flag output which warns of a low output voltage, often due to falling battery voltage on the input. It may be used for a power-on reset. A second feature is the logic-compatible shutdown input which enables the regulator to be switched on and off. Also, the part may be pin-strapped for a 5V output or programmed from 1.24V to 29V with an external pair of resistors.

Careful design of the LP2951 has minimized all contributions to the error budget. This includes a tight initial tolerance(0.5% typ.), extremely good load and line regulation (0.05% typ.) and a very low output voltage temperature coefficient, making the part useful as a low-power voltage reference.

#### Industry Part Number

LP2951

Prime Die

LP2951

#### NS Part Numbers

LP2951E/883\*  
LP2951H/883\*\*  
LP2951J/883\*\*\*  
LP2951WG/883\*\*\*\*

#### Controlling Document

See Features Page

#### Processing

MIL-STD-883, Method 5004

#### Quality Conformance Inspection

MIL-STD-883, Method 5005

Subgrp	Description	Temp ( °C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

**Features**

- Error flag warns of output dropout.
- Logic-controlled electronic shutdown.
- Output programmable from 1.24 to 29V.
- SMD : 5962-38705M2A\*, MGA\*\*, MPA\*\*\*, MXA\*\*\*\*

### (Absolute Maximum Ratings)

(Note 1)

Power Dissipation		
METAL CAN	675mW at +25 C	
CERDIP	1.0W at +25 C	
LCC	1.25W at +25 C	
CERAMIC SOIC	1.0W at +25 C	
Storage Temperature Range	-65 C to +150 C	
Operating Ambient Temperature Range	-55 C to +125 C	
Absolute Maximum Junction Temperature	+160 C	
Input Supply Voltage	-0.3 to +30V	
Feedback Input Voltage (Note 3, 4)	-1.5 to +30V	
Shutdown Input Voltage (Note 3)	-0.3 to +30V	
Error Comparator Out. Voltage (Note 3)	-0.3 to +30V	
Lead Temperature (Soldering, 10 seconds)	260 C	
Thermal Resistance		
Theta <sub>JA</sub>		
METAL CAN	(Still Air @ 0.5W) 163 C/W (500LF/Min Air flow @ 0.5W) 95 C/W	
CERDIP	(Still Air @ 0.5W) 131 C/W (500LF/Min Air flow @ 0.5W) 75 C/W	
LCC	(Still Air @ 0.5W) 95 C/W (500LF/Min Air flow @ 0.5W) 66 C/W	
CERAMIC SOIC	(Still Air @ 0.5W) 215 C/W (500LF/Min Air flow @ 0.5W) 130 C/W	
Theta <sub>JC</sub>		
METAL CAN	51 C/W	
CERDIP	21 C/W	
LCC	24 C/W	
CERAMIC SOIC	24 C/W	
Package Weight (Typical)	TBD	
ESD Rating	500V	

- Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- Note 2: The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{jmax}$  (maximum junction temperature),  $\Theta_{JA}$  (package junction to ambient thermal resistance), and  $TA$  (ambient temperature). The maximum allowable power dissipation at any temperature is  $P_{dmax} = (T_{jmax} - TA)/\Theta_{JA}$  or the number given in the Absolute Maximum Ratings, whichever is lower.
- Note 3: May exceed input supply voltage.
- Note 4: When used in dual-supply systems where the output terminal uses loads returned to a negative supply, the output voltage should be diode-clamped to ground.

## Electrical Characteristics

### DC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)  
 DC: Vin = 6V, Il = 100uA, Cl = 1uF, Vout = 5V, Vshutdown = ≤ 0.8V

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
	Output Voltage				4.975	5.025	V	1
					4.94	5.06	V	2, 3
	Line Regulation	6V ≤ Vin ≤ 30V			-5	5	mV	1
		Il = 1mA			-25	25	mV	2, 3
	Load Regulation	100uA ≤ Il ≤ 100mA			-5	5	mV	1
		100uA ≤ Il ≤ 100mA			-25	25	mV	2, 3
	Dropout Voltage	Il = 100mA	1, 2		450	mV	1	
					600	mV	2, 3	
			1, 2		80	mV	1	
					150	mV	2, 3	
	Ground Current	Vout = 15V, Il = 100mA			0	15	mA	1
					0	20	mA	2, 3
		Il = 100mA			0	12	mA	1
					0	14	mA	2, 3
					0	30	uA	1
		Vin = 6-30V			0	50	uA	2, 3
					0	120	uA	1
	Quiescent Ground Current				0	140	uA	2, 3
					0	120	uA	1
		Il = 10uA, Vout = 15V			0	140	uA	2, 3
					0	120	uA	1
	Dropout Ground Current	Vin = 4.5V			0	170	uA	1
					0	200	uA	2, 3
	Comparator Lower Threshold		1, 3		95	mV	1	
					140	mV	2, 3	
	Comparator Upper Threshold		1, 3		40		mV	1
					25		mV	2, 3
	Thermal Regulation	Vin = 30V, Il = 50mA, T = 2mS			-12.5	12.5	mV	1
		Vin = 30V, Il = 50mA, T = 10mS			-12.5	12.5	mV	1
	ISC Current Limit	Vout = 0V			0	200	mA	1
					0	220	mA	2, 3

## Electrical Characteristics

### DC PARAMETERS (Continued)

(The following conditions apply to all the following parameters, unless otherwise specified.)  
 DC: Vin = 6V, Il = 100uA, Cl = 1uF, Vout = 5V, Vshutdown = ≤ 0.8V

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
	Reference Voltage				1.22	1.25	V	1
					1.20	1.26	V	2, 3
	Reference Line Regulation	2.3V ≤ Vin ≤ 30V			-1.9	1.9	mV	1
		2.3V ≤ Vin ≤ 30V			-10	10	mV	2, 3
	Reference Output Regulation	Vref ≤ Vout ≤ (Vin-1V), Vin = 30V			-1.2	1.2	mV	1
		Vref ≤ Vout ≤ (Vin-1V), Vin = 30V			-5	5	mV	2, 3
	Feedback Bias Current				-40	40	nA	1
					-60	60	nA	2, 3
	Comparator Off Leakage	Vo = 30V			-1	1	uA	1
					-2	2	uA	2, 3
	Comparator Output Low Voltage	Vin = 4.5V, Iol = 400uA			0	250	mV	1
					0	400	mV	2, 3
	Shutdown Input Current	Vshutdown = 2.4V			0	50	uA	1
					0	100	uA	2, 3
		Vshutdown = 30V			0	600	uA	1
					0	750	uA	2, 3
	Output Leakage Current in Shutdown	Vshutdown = 1.5V, Vin = 30V			-10	10	uA	1
					-20	20	uA	2, 3
	Shutdown Input Logic Voltage	(LOW)	1			0.6	V	1, 2, 3
		(HIGH)			2		V	1, 2, 3

Note 1: Functional test only.

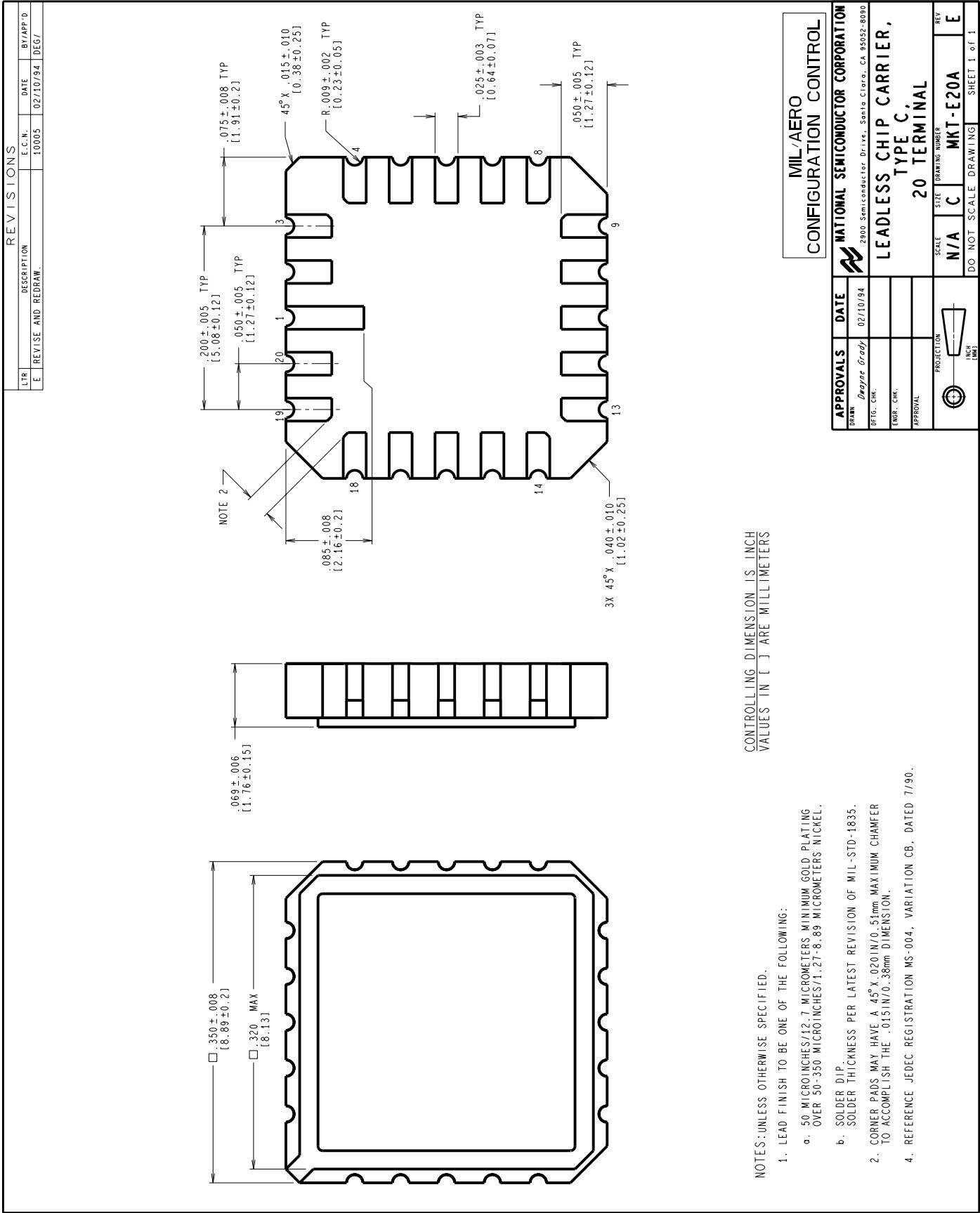
Note 2: Dropout voltage is defined as the input to output differential at which the output drops 100mV below its nominal values measured at 1V differential. At very low values of programmed output voltage, the minimum input supply voltage of 2V (2.3V over temperature) must be taken into account.

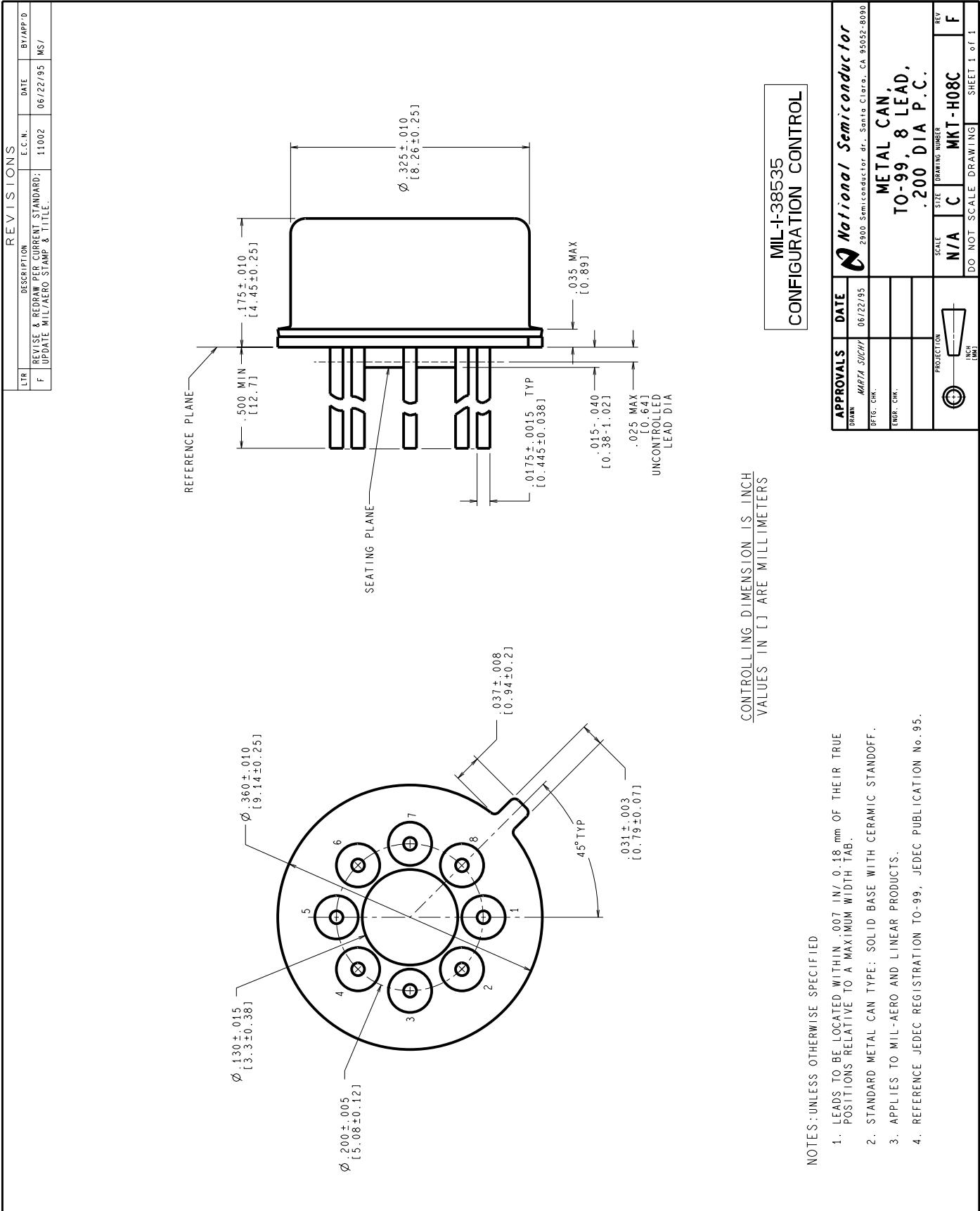
Note 3: Comparator thresholds are expressed in terms of a voltage differential at the Feedback terminal below the nominal reference voltage measured at Vin = 6V. To express these thresholds in terms of output voltage change, multiply by the error amplifier Gain=Vout/Vin=(R1 + R2)R2. For example, at a programmed output voltage of 5V, the error output is guaranteed to go low when the output drops by 95mV X 5V/1.235V = 384mV. Thresholds remain constant as a percent of Vout as Vout is varied, with the dropout warning occurring at typically 5% below nominal, 7.5% guaranteed.

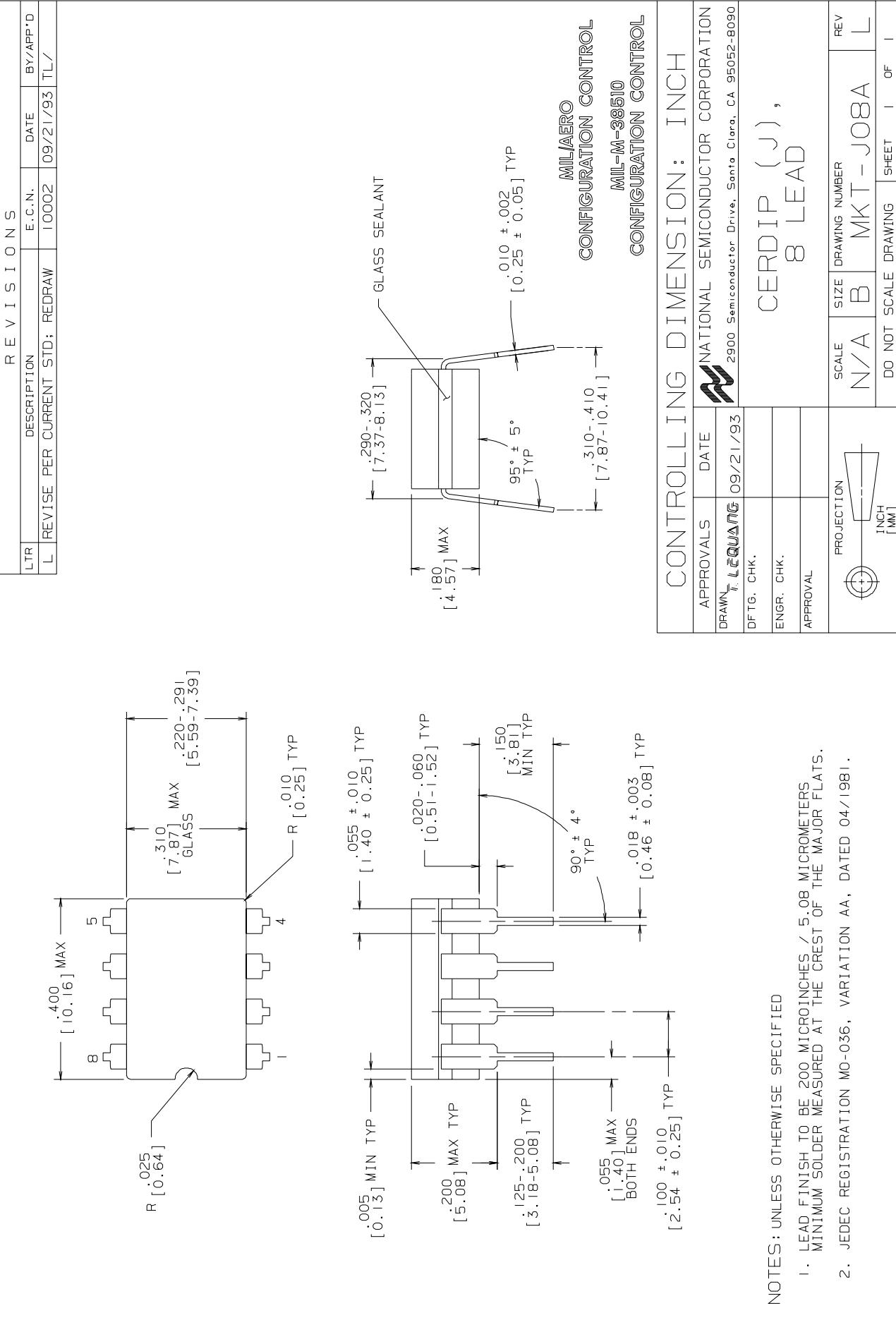
## Graphics and Diagrams

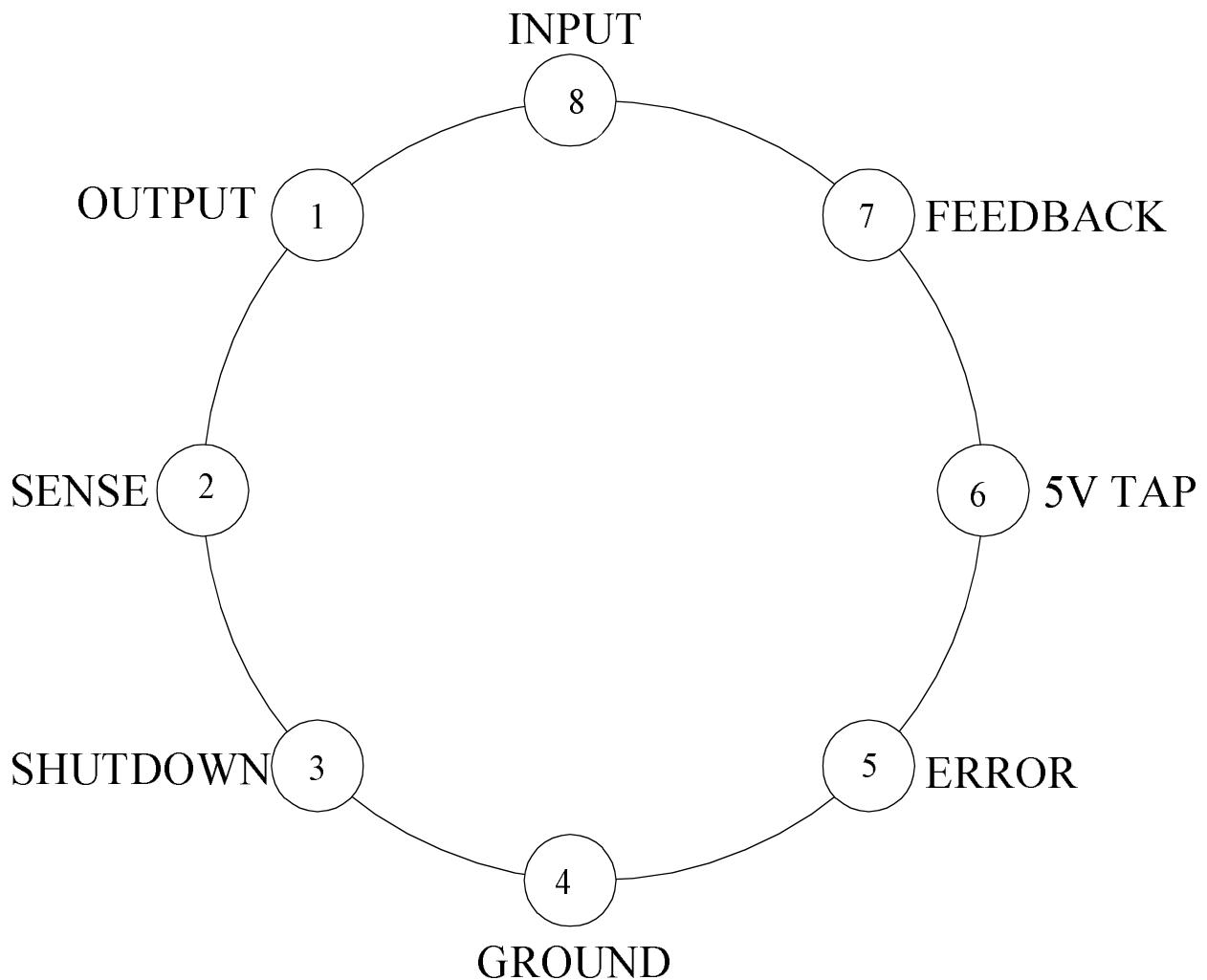
GRAPHICS#	DESCRIPTION
05810HRA2	METAL CAN (H), TO-99, 8LD, .200 DIA P.C. (B/I CKT)
06059HRA2	CERDIP (J), 8 LEAD (B/I CKT)
06146HRA2	LCC (E), TYPE C, 20 TERMINAL(B/I CKT)
06341HRA1	CERPACK (W), 10 LEAD (B/I CKT)
E20ARE	LCC (E), TYPE C, 20 TERMINAL(P/P DWG)
H08CRF	METAL CAN (H), TO-99, 8LD, .200 DIA P.C. (P/P DWG)
J08ARL	CERDIP (J), 8 LEAD (P/P DWG)
P000205A	METAL CAN (H), 8 LEAD (PINOUT)
P000206A	CERDIP (J), 8 LEAD (PINOUT)
P000251B	LCC (E), 20 LEAD (PINOUT)
P000374A	CERAMIC SOIC (WG), 10 LEAD (PINOUT)
WG10ARC	CERAMIC SOIC (WG), 10 LEAD (P/P DWG)

See attached graphics following this page.

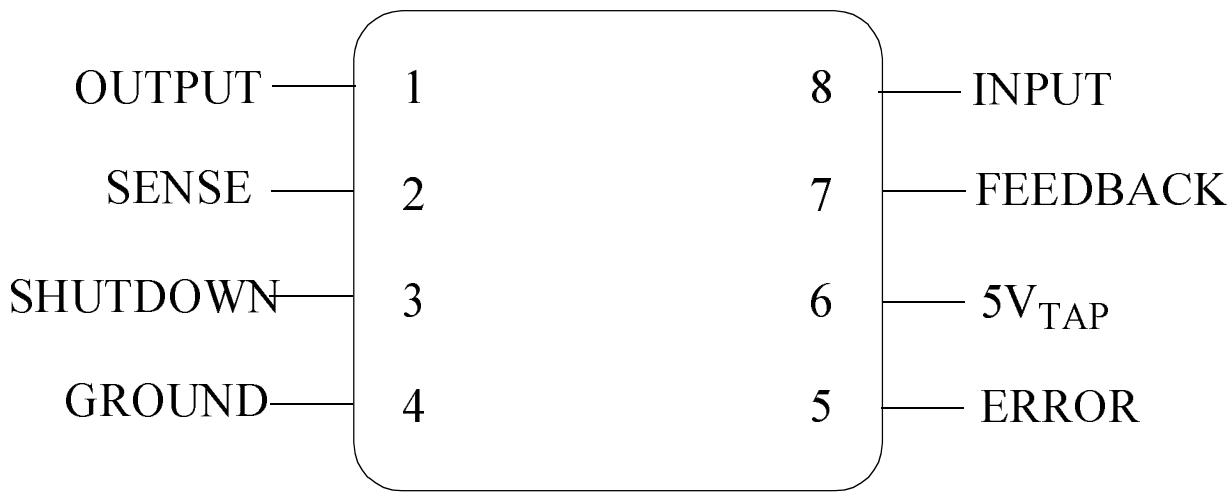




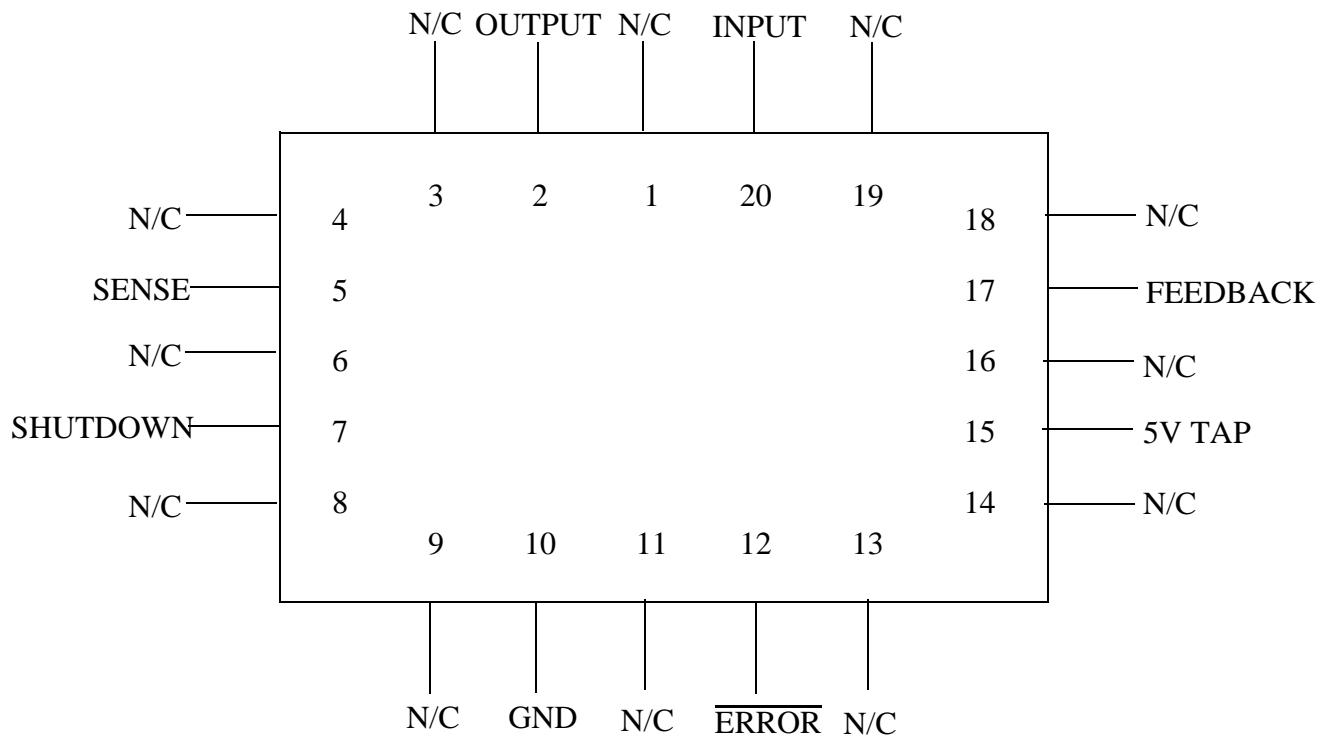




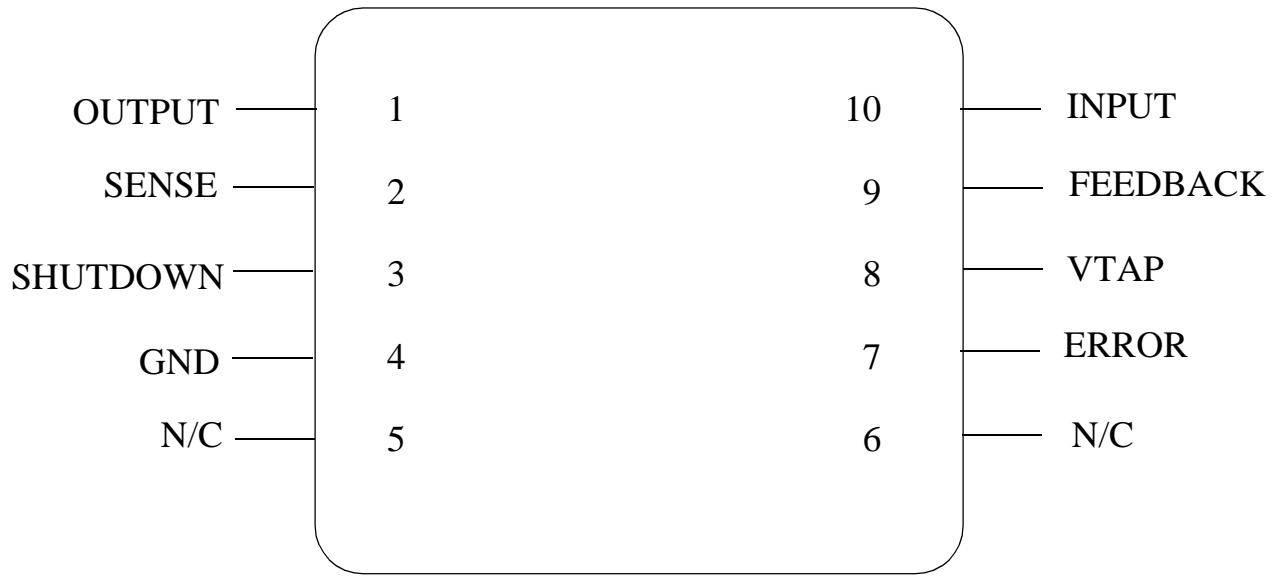
**LP2951H**  
**8 - PIN METAL CAN**  
**CONNECTION DIAGRAM**  
**TOP VIEW**  
**P000205A**



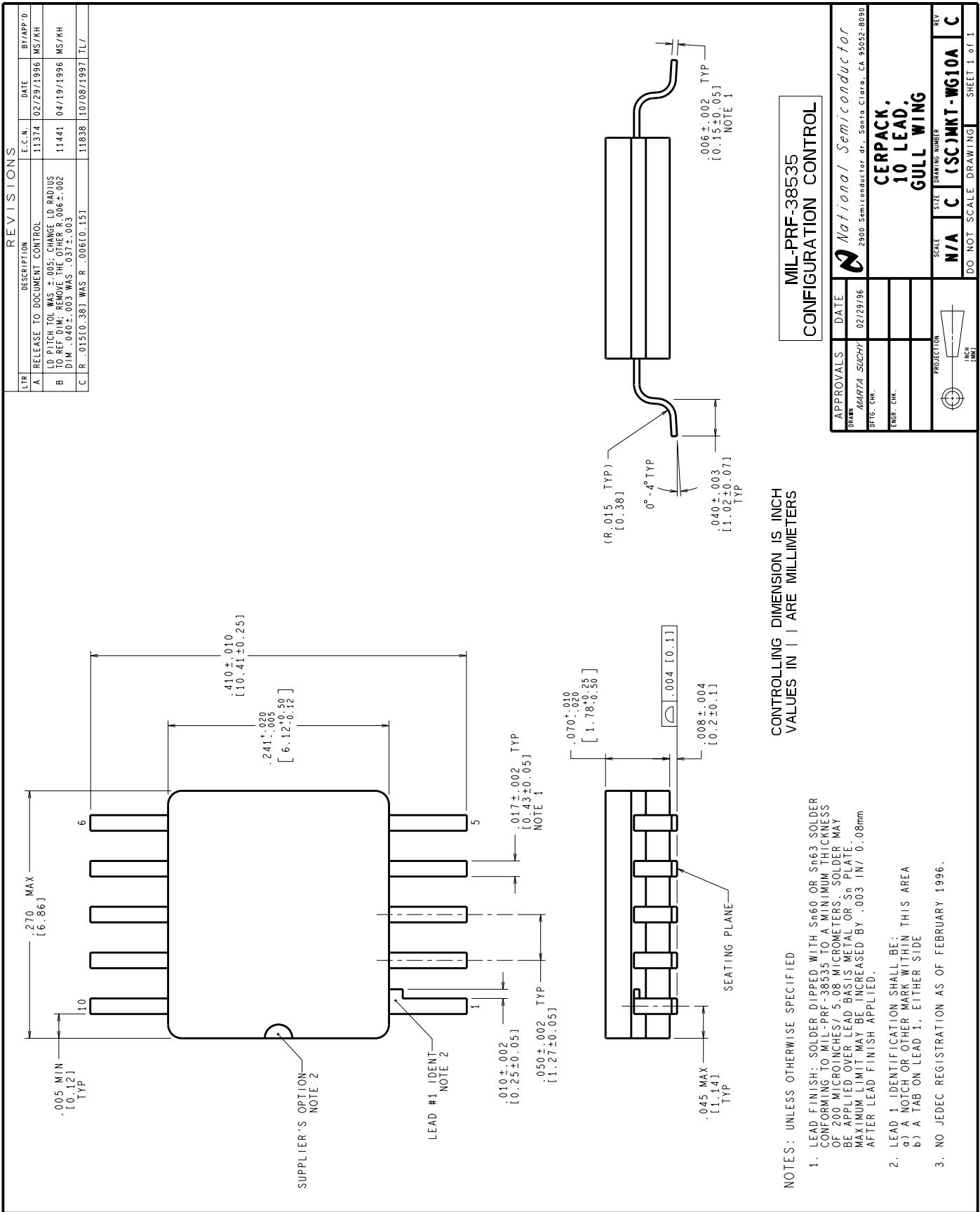
**LP2951J**  
**8 - LEAD DIP**  
**CONNECTION DIAGRAM**  
**TOP VIEW**  
**P000206A**



**LP2951E**  
**20 - LEAD LCC**  
**CONNECTION DIAGRAM**  
**TOP VIEW**  
**P000251B**



**LP2951WG**  
**10 - LEAD CERAMIC SOIC**  
**CONNECTION DIAGRAM**  
**TOP VIEW**  
**P000374A**



**Revision History**

<b>Rev</b>	<b>ECN #</b>	<b>Rel Date</b>	<b>Originator</b>	<b>Changes</b>
1B1	M0002864	05/19/98	Barbara Lopez	Update MDS: MNLP2951-X Rev. 1A0 to MNLP2951-X Rev. 1B1. Added WG package to SMD number and NSID. Updated power dissipation to reflect all packages. Updated thermal resistance to reflect all packages. Updated ESD rating. Updated Absolute junction temperature. Added graphics for all packages. Added Package Weights.